Radiation Damage Behavior in Multiphase Ceramics

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Ceramics belong to the promising class of radiation damage resistant materials. In particular, nanocrystalline ceramics have been observed to be more tolerant to radiation damage than ceramics with larger grains [1,2,3]. In highly radiation damage tolerant materials, the defect annihilation counteracts and mitigates radiation damage. One route to annihilate defects is the migration of point defects to grain boundaries, which act as efficient sinks for defects. Defect migration to the grain boundaries can be enhanced by shortening the distance between the grain boundary sinks and the defects, which is why the finer grain size (nano-crystalline) improves radiation damage tolerance. However, at high temperatures, which typically exist in a nuclear reactor, nano-grains in single-phase materials will grow and irradiation induces additional grain growth,[1,2,3] Once the grains grow larger, the material will no longer be as radiation resistant.

The objective of this study is to engineer new composite materials that will retain the fine grain size under irradiation. The approach is based on using multiple phases of different chemical compositions that inhibit grain growth by blocking the diffusion pathway between like phases.[4] We have selected a 3-phase ceramic that consist of yttria stabilized zirconia (YSZ), alumina (Al2O3), Mg-spinel (MgAl2O4). The radiation induced modifications and defects in each of the single phases have been widely studied [1,3,5,6]. 3-phase composite of 8 mol% yttria stabilized zirconia (8YSZ), Al2O3 and MgAl2O4 with grain size of 500 nm were sintered by 2-step sintering with 1450 °C and 5 hours dwelling at 1325°C and single crystals of each composition were irradiated at 650 °C with 4 MeV Si ion beam with fluent of 1x1016 atom/cm2. Single crystals of each phase were also irradiated to demonstrate the extreme condition with large grain size (no grain boundary).

GIXRD, SEM and TEM were used to analyze microstructural changes and crystals structural changes in irradiated samples. There was no phase transformation or grain growth detected by XRD and SEM in 3-phase sample. All phases formed dislocation loops in single crystals (Fig. 1) accumulated at the damage peak region, which was estimated to be 1.5-2 μm from the surface. Especially in Al2O3, the loops were found throughout the damaged zone. In 3-phase sample, 8YSZ grains and MgAl2O4 grain showed high radiation damage tolerance by having less dislocation loops whereas Al2O3 has dislocation loops throughout the damaged zone as in the single crystal (Fig. 1). In 8YSZ grains, intrinsic defects and/or damage from sample preparation using focused ion beam give strong contrast other than damage due to irradiation, which makes it difficult to analyze the dislocation loops generated by the irradiation. Regardless, a band of region with dislocation loops was not observed. In MgAl2O4 grains, dislocation loop density is lower than in single crystal (Fig. 1 and 2). For 8YSZ and MgAl2O4 grains, having grain boundaries increased radiation damage tolerance. The high radiation damage tolerance, especially in single crystals, for YSZ and MgAl2O4 is due to their intrinsic properties [7,8]. The scope of this study will be to seek for the grain size with which materials with radiation damage tolerance such as Al2O3 have less damage.
References
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Figure 1. BF TEM images of single crystals and 3-phase irradiated with 4 MeV Si ions at 650°C. Red dotted box indicates the damage accumulated region with high dislocation density. The inserted graph indicates damage distribution with respect to target depth estimated by SRIM.

Figure 2. SAD (a), BF (b) and DF (c) image of MgAl₂O₄ grain in damaged region. g=220 near [110]. Red arrows indicates traces of dislocation loops.